

Title (en)

Connecting element and method of manufacturing a connecting element

Title (de)

Verbindungselement und Verfahren zur Herstellung eines Verbindungselements

Title (fr)

Élément de connexion et procédé de fabrication d'un élément de connexion

Publication

**EP 2763243 A1 20140806 (EN)**

Application

**EP 13153250 A 20130130**

Priority

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Abstract (en)

The invention relates to a connecting element (100) for establishing an electrically conductive connection between two further elements (200, 300), particularly for connecting a body unit (200) of a grounding kit (1000) with a grounding element (300), wherein said connecting element (100) comprises at least two layers (102a, 102b) of electrically conductive material, wherein at least two layers (102a, 102b) comprise different material.

IPC 8 full level

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CPC (source: EP)

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Citation (search report)

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Designated contracting state (EPC)

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